

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6800185

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	TAKASHI DOBASHI	06/11/2021
	HIROKAZU TAMAKI	06/22/2021
	HIROMI MISE	06/11/2021
RECEIVING PARTY DATA		
Name:	HITACHI HIGH-TECH CORPORATION	
Street Address:	17-1, TORANOMON 1-CHOME	
City:	MINATO-KU, TOKYO	
State/Country:	JAPAN	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	17421147
CORRESPONDENCE DATA		
Fax Number:	(703)610-8686	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	703- 903-9000	
Email:	mleahy@milesstockbridge.com, ipdocketing@MilesStockbridge.com	
Correspondent Name:	MILES & STOCKBRIDGE, P.C.	
Address Line 1:	1751 PINNACLE DRIVE, SUITE 1500	
Address Line 4:	TYSONS CORNER, VIRGINIA 22102-3833	
ATTORNEY DOCKET NUMBER:	T4323-24086US01	
NAME OF SUBMITTER:	MADELIENE B. LEAHY	
SIGNATURE:	/Madelienne B. Leahy/	
DATE SIGNED:	07/07/2021	
Total Attachments: 3		
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source=T4323-24086US01 - Assignment#page3.tif		

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Tech Corporation, a corporation organized under the laws of Japan, located at 17-1, Toranomon 1-chome, Minato-ku, Tokyo Japan receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Tech Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

CHARGED PARTICLE BEAM DEVICE AND CONTROL METHOD THEREOF

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Tech Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Tech Corporation,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) <u>Takashi Dobashi</u>	Takashi DOBASHI	<u>Jun 11, 2021</u>
2) _____	Hirokazu TAMAKI	_____
3) _____	Hiromi MISE	_____
4) _____		_____
5) _____		_____
6) _____		_____
7) _____		_____
8) _____		_____
9) _____		_____
10) _____		_____

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INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) _____ Takashi DOBASHI

2) Hirokazu Tamaki _____ Hirokazu TAMAKI

June 22, 2021 _____

3) _____ Hiromi MISE

4) _____

5) _____

6) _____

7) _____

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10) _____

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2)	Hirokazu TAMAKI	
3)	<i>Hiromi MISE</i> Hiromi MISE	<i>June 11, 2021</i>
4)		
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